

## **10 Mbps ARCNET (ANSI 878.1) Controller with 2Kx8 On-Chip RAM**

### **Data Brief**

### **Product Features**

---

- **New Features**
  - Data Rates up to 10 Mbps
  - Selectable 8/16 Bit Wide Bus With Data Swapper
  - Programmable Reconfiguration Times
- 48 Pin TQFP Package; Lead-Free RoHS Compliant package also available
- Ideal for Industrial/Factory/Building Automation and Transportation Applications
- Deterministic, (ANSI 878.1), Token Passing ARCNET Protocol
- Minimal Microcontroller and Media Interface Logic Required
- Flexible Interface For Use With All Microcontrollers or Microprocessors
- Automatically Detects Type of Microcontroller Interface
- 2Kx8 On-Chip Dual Port RAM
- Command Chaining for Packet Queuing
- Sequential Access to Internal RAM
- Software Programmable Node ID
- Eight, 256 Byte Pages Allow Four Pages TX and RX Plus Scratch-Pad Memory
- Next ID Readable
- Internal Clock Scaler and Clock Multiplier for Adjusting Network Speed
- Operating Temperature Range of -40°C to +85°C
- 3.3V power supply with 5V tolerant I/O
- Self-Reconfiguration Protocol
- Supports up to 255 Nodes
- Supports Various Network Topologies (Star, Tree, Bus...)
- CMOS, Single +3.3V Supply
- Duplicate Node ID Detection
- Powerful Diagnostics
- Receive All Packets Mode
- Flexible Media Interface:
  - Traditional Hybrid Interface For Long Distances at 2.5Mbps
  - RS485 Differential Driver Interface For Low Cost, Low Power, High Reliability

### **ORDERING INFORMATION**

#### **Order Numbers:**

COM20022I3V-HD for 48 pin TQFP package

COM20022I3V-HT for 48 pin, TQFP Lead-Free RoHS Compliant package



80 ARKAY DRIVE, HAUPPAUGE, NY 11788 (631) 435-6000, FAX (631) 273-3123

Copyright © 2007 SMSC or its subsidiaries. All rights reserved.

Circuit diagrams and other information relating to SMSC products are included as a means of illustrating typical applications. Consequently, complete information sufficient for construction purposes is not necessarily given. Although the information has been checked and is believed to be accurate, no responsibility is assumed for inaccuracies. SMSC reserves the right to make changes to specifications and product descriptions at any time without notice. Contact your local SMSC sales office to obtain the latest specifications before placing your product order. The provision of this information does not convey to the purchaser of the described semiconductor devices any licenses under any patent rights or other intellectual property rights of SMSC or others. All sales are expressly conditional on your agreement to the terms and conditions of the most recently dated version of SMSC's standard Terms of Sale Agreement dated before the date of your order (the "Terms of Sale Agreement"). The product may contain design defects or errors known as anomalies which may cause the product's functions to deviate from published specifications. Anomaly sheets are available upon request. SMSC products are not designed, intended, authorized or warranted for use in any life support or other application where product failure could cause or contribute to personal injury or severe property damage. Any and all such uses without prior written approval of an Officer of SMSC and further testing and/or modification will be fully at the risk of the customer. Copies of this document or other SMSC literature, as well as the Terms of Sale Agreement, may be obtained by visiting SMSC's website at <http://www.smsc.com>. SMSC is a registered trademark of Standard Microsystems Corporation ("SMSC"). Product names and company names are the trademarks of their respective holders.

**SMSC DISCLAIMS AND EXCLUDES ANY AND ALL WARRANTIES, INCLUDING WITHOUT LIMITATION ANY AND ALL IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, TITLE, AND AGAINST INFRINGEMENT AND THE LIKE, AND ANY AND ALL WARRANTIES ARISING FROM ANY COURSE OF DEALING OR USAGE OF TRADE. IN NO EVENT SHALL SMSC BE LIABLE FOR ANY DIRECT, INCIDENTAL, INDIRECT, SPECIAL, PUNITIVE, OR CONSEQUENTIAL DAMAGES; OR FOR LOST DATA, PROFITS, SAVINGS OR REVENUES OF ANY KIND; REGARDLESS OF THE FORM OF ACTION, WHETHER BASED ON CONTRACT; TORT; NEGLIGENCE OF SMSC OR OTHERS; STRICT LIABILITY; BREACH OF WARRANTY; OR OTHERWISE; WHETHER OR NOT ANY REMEDY OF BUYER IS HELD TO HAVE FAILED OF ITS ESSENTIAL PURPOSE, AND WHETHER OR NOT SMSC HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.**



## General Description

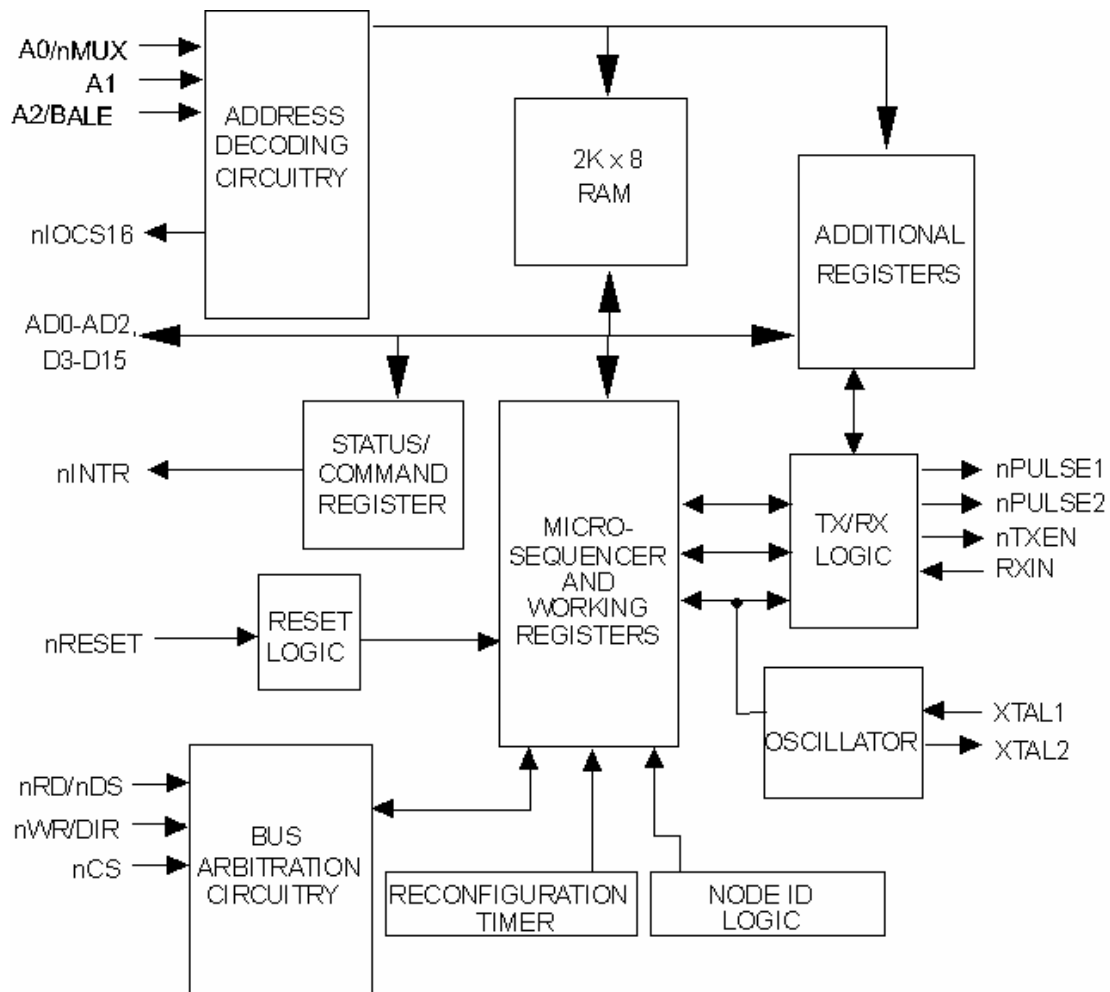
---

SMSC's COM20022I 3V is a member of the family of Embedded ARCNET Controllers from Standard Microsystems Corporation. The device is a general purpose communications controller for networking microcontrollers and intelligent peripherals in industrial and embedded control environments using an ARCNET protocol engine. The small 48 pin package, flexible microcontroller and media interfaces, eight-page message support, and extended temperature range of the COM20022I 3V make it the only true network controller optimized for use in industrial and embedded applications. Using an ARCNET protocol engine is the ideal solution for embedded control applications because it provides a deterministic token-passing protocol, a highly reliable and proven networking scheme, and a data rate of up to 10 Mbps when using the COM20022I 3V. A token-passing protocol provides predictable response times because each network event occurs within a predetermined time interval, based upon the number of nodes on the network. The deterministic nature of ARCNET is essential in real time applications. The integration of the 2Kx8 RAM buffer on-chip, the Command Chaining feature, the 10 Mbps maximum data rate, and the internal diagnostics make the COM20022I 3V the highest performance embedded communications device available. With only one COM20022I 3V and one microcontroller, a complete communications node may be implemented.

**NOTE:** For more details on the ARCNET protocol engine and traditional dipulse signaling schemes, please refer to the ARCNET Local Area Network Standard, or the ARCNET Designer's Handbook, available from Datapoint Corporation.

# Block Diagram

---



**Figure 1 - Internal Block Diagram**

## Package Outline

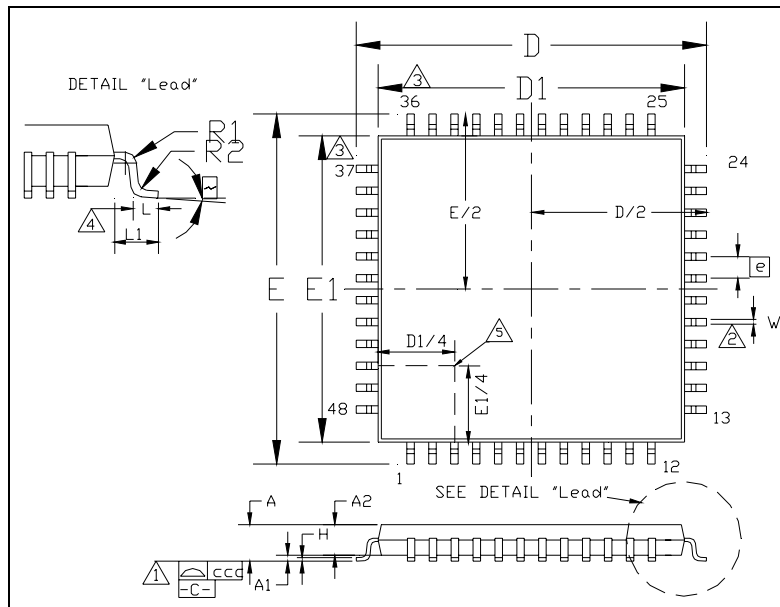


Figure 2 - 48 Pin TQFP Package Outline

Table 1 - 48 Pin TQFP Package Parameters

	MIN	NOMINAL	MAX	REMARK
A	~	~	1.6	Overall Package Height
A1	0.05	0.10	0.15	Standoff
A2	1.35	1.40	1.45	Body Thickness
D	8.80	9.00	9.20	X Span
D/2	4.40	4.50	4.60	<sup>1</sup> / <sub>2</sub> X Span Measure from Centerline
D1	6.90	7.00	7.10	X body Size
E	8.80	9.00	9.10	Y Span
E/2	4.40	4.50	4.60	<sup>1</sup> / <sub>2</sub> Y Span Measure from Centerline
E1	6.90	7.00	7.10	Y body Size
H	0.09	~	0.20	Lead Frame Thickness
L	0.45	0.60	0.75	Lead Foot Length from Centerline
L1	~	1.00	~	Lead Length
e	0.50 Basic			Lead Pitch
θ	0°	~	7°	Lead Foot Angle
W	0.17	~	0.27	Lead Width
R1	0.08	~	~	Lead Shoulder Radius
R2	0.08	~	0.20	Lead Foot Radius
ccc	~	~	0.08	Coplanarity (Test House)

### Notes:

- 1) Controlling Unit: millimeter
- 2) Tolerance on the position of the leads is  $\pm 0.04$  mm maximum.
- 3) Package body dimensions D1 and E1 do not include the mold protrusion. Maximum mold protrusion is 0.25 mm.
- 4) Dimension for foot length L measured at the gauge plane 0.25 mm above the seating plane is 0.78-1.08 mm.
- 5) Details of pin 1 identifier are optional but must be located within the zone indicated.

## Данный компонент на территории Российской Федерации

### Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9